





IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Applicant:

Robert F. Wallace

Assignee:

SanDisk Corporation

Title:

Semiconductor Package Using Terminals Formed on a Conductive

Layer of a Circuit Board

Application No.:

09/866,022

Filing Date:

May 24, 2001

Examiner:

Potter, Roy Karl

Group Art Unit:

2822

Docket No.:

M-10238-2C US

Conf. No.:

6172

San Francisco, California February 272 2003 HAR 10 2003

Commissioner for Patents Washington, D.C. 20231

RESPONSE TO OFFICE ACTION

Sir:

PARSONS HSUE & DE RUNTZ LLP

Metro Drive, Suite 700 ian Jose, CA 95110 (408) 453-9200 Fax (408) 453-7979 In response to the Office Action dated October 3, 2002, a Terminal Disclaimer is being filed herewith. Since this is believed to overcome the non-statutory double patenting rejection, allowance of the present application is in order.

However, it is noted that there is no record in the file of the undersigned attorney that the Information Disclosure Statement filed with the application has been considered. Therefore, a copy is being filed herewith. Consideration of each of the references listed on its 2 pages of Form PTO 1449 is respectfully requested. A return of the 1449s with the Examiner's initials is also solicited.

EXPRESS MAIL LABEL NO:

Respectfully submitted,

EU877118127US

Gerald P. Parsons

Attorney for Applicant

Reg. No. 24,486

Application No.: 09/866,022

Express Mail No.: EU877118127US

- 1 -

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